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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Golan HANIA, et al

Serial No.: 10/045,651 : Group No.: 2825
Filed: November 7, 2001 : Examiner: Not yet assigned
For: **MULTI-LAYER PRINTED CIRCUIT BOARD
FABRICATION SYSTEM**

May 30, 2002

Hon. Commissioner of Patents and Trademarks
Washington D.C. 20231

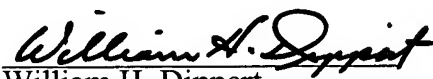
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